

Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at www.onsemi.com

Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (_), the underscore (_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at www.onsemi.com. Please email any questions regarding the system integration to Fairchild guestions@onsemi.com.

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officer



April 2014

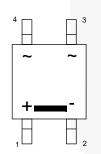
MB1S - MB8S 0.5 A Bridge Rectifiers

Features

- · Low-Leakage
- · Surge Overload Rating: 35 A peak
- · Ideal for Printed Circuit Board
- UL Certified: UL #E258596



SOIC-4
Polarity symbols molded or mark on body



Description

The MB family of bridge rectifiers is a 0.5 A rectifier family that achieves high surge current absorption within a very small foot print. Within its small 35 mm² form factor, the MB family shines in its surge capability. In order to absorb high surge currents, the design supports a 35 A I_{FSM} rating and a 5.0 A²Sec I²T rating. Devices in the family are also rated to breakdown voltages of up to 1000 V. These features make the MB family ideal for small power supplies that need a little extra surge capability.

For higher I_{FAV} current ratings, lower profile packaging, or lower V_F values, explore the Fairchild MDB family of bridge rectifiers. For improved V_F and efficiency values in the MB package or even higher surge capability, ask about Fairchild's pending MBxSV family.

Ordering Informations

| Part Number | Marking | Package | Packing Method |
|-------------|---------|---------|----------------|
| MB1S | MB1S | | |
| MB2S | MB2S | | |
| MB4S | MB4S | SOIC-4 | Tape and Reel |
| MB6S | MB6S | | |
| MB8S | MB8S | 7 | |

Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^{\circ}\text{C}$ unless otherwise noted.

| Symbol | Parameter | Value | | | | Unit | |
|--------------------|--|-------------|------|---------|------|------|-------|
| | Falailletei | | MB2S | MB4S | MB6S | MB8S | Oiiit |
| V_{RRM} | Maximum Repetitive Reverse Voltage | 100 | 200 | 400 | 600 | 800 | V |
| V _{RMS} | Maximum RMS Bridge Input Voltage | 70 | 140 | 280 | 420 | 560 | V |
| V _R | DC Reverse Voltage (Rated V _R) | 100 | 200 | 400 | 600 | 800 | V |
| I _{F(AV)} | Average Rectified Forward Current at T _A = 50°C | 0.5 | | Α | | | |
| I _{FSM} | Non-Repetitive Peak Forward Surge Current: 8.3 ms Single Half-Sine-Wave | 35 | | Α | | | |
| T _{STG} | Storage Temperature Range | -55 to +150 | | °C | | | |
| TJ | Operating Junction Temperature Range | | -5 | 5 to +1 | 50 | | °C |

Thermal Characteristics

| Symbol | Parameter | Value | Unit |
|-----------------|---|-------|------|
| P_{D} | Power Dissipation | 1.4 | W |
| $R_{\theta JA}$ | Thermal Resistance, Junction to Ambient, per Leg ⁽¹⁾ | 85 | °C/W |
| $R_{	heta JL}$ | Thermal Resistance, Junction to Lead, per Leg ⁽¹⁾ | 20 | °C/W |

Note:

1. Device mounted on PCB with 0.5 x 0.5 inch (13 x 13 mm) lead length.

Electrical Characteristics

Values are at T_A = 25°C unless otherwise specified.

| Symbol | Parameter | Conditions | Value | Unit |
|------------------|--|--|-------|------------------|
| V_{F} | Forward Voltage, per Bridge | I _F = 0.5 A | 1.0 | V |
| I _R | Reverse Current, per Leg at Rated V _R | T _A = 25°C | 5.0 | μΑ |
| | | T _A = 125°C | 0.5 | mA |
| l ² t | I ² t Rating for Fusing | t < 8.3 ms | 5.0 | A ² s |
| C _T | Total Capacitance, per Leg | V _R = 4.0 V, f = 1.0 MHz | 13 | pF |

Typical Performance Characteristics

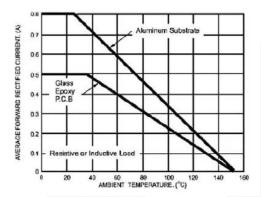


Figure 1. Derating Curve for Output Rectified Current

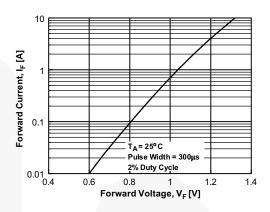


Figure 2. Forward Voltage Characteristics

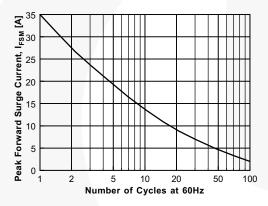


Figure 3. Non-Repetitive Surge Current

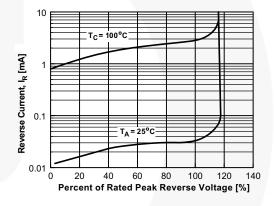
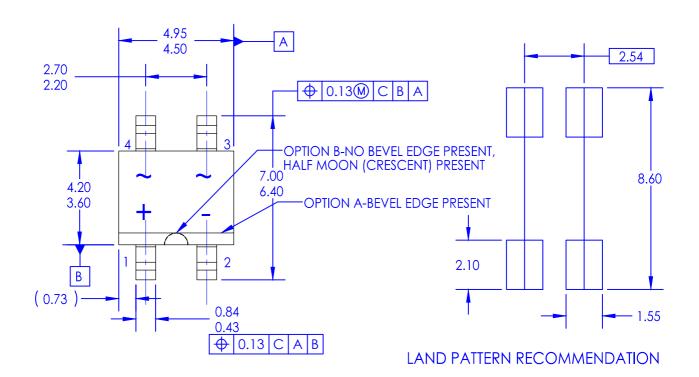
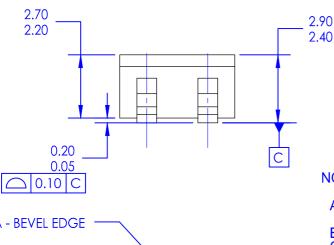
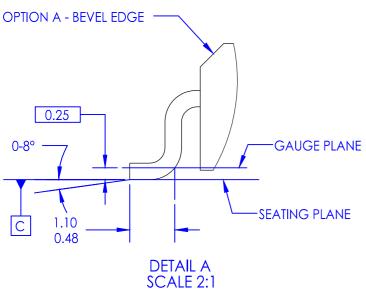
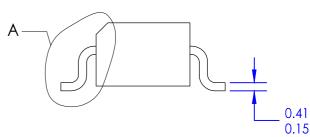


Figure 4. Reverse Current vs. Reverse Voltage









NOTES: UNLESS OTHERWISE SPECIFIED

- A. THIS PACKAGE DOES NOT CONFORM TO JEDEC TO269AA

- B. ALL DIMENSIONS ARE IN MILLIMETERS.
 C. DIMENSIONS ARE EXCLUSIVE OF BURRS,
 MOLD FLASH AND TIE BAR EXTRUSIONS.
 D. DIMENSIONS AND TOLERANCES AS PER ASME Y14.5-2009.
- E. LAND PATTERN AS PER IPC7351# SOIC254P960X400-4N
- F. FILE NAME: MKT-M04AREV3



ON Semiconductor and in are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdt/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and exp

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada
Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81–3–5817–1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

ON Semiconductor:

MB6S